



PATENTS

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Appl. No. 10/758,487 Confirmation No.:  
Applicant(s): HIROFUMI KURODA  
Filed: January 15, 2004  
TC/A.U. TBA  
Examiner: TBA  
Title: EPOXY RESIN COMPOSITION AND SEMICONDUCTOR DEVICE  
USING THEREOF

Docket No.: 033036.070  
Customer No.: 25461

**MAIL STOP NONFEE AMENDMENT**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**PRELIMINARY AMENDMENT**

Prior to the first examination of the above-identified application, please amend the application as follows:

**Amendments to the Specification** are reflected beginning on page 2 of this paper.

**Amendments to the Claims** are reflected in the listing of claims which begins on page 3 of this paper.

**Remarks/Arguments** begin on page 12 of this paper.

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**CERTIFICATE OF MAILING**

I hereby certify that this correspondence is being deposited with the United States Postal Service addressed to Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on April 20, 2004.

*Lucy Kimsey*  
Lucy Kimsey